









Release Date: 01 April 2015 Version: A1.0

PRODUCT DATASHEET



- ► PLCC2 SMD
- ➤ 2835 0.8t Series
- ► Natural White (4000K)

N0W15S87





2835 0.8t Series





FEATURES:

Package: PLCC2 White SMD Package

Forward Current: 60mA Forward Voltage (typ.): 3.2V

Luminous Flux (typ.): 22lm@60mA

Colour: Natural White

Colour Temperature (CCT): 4000K

Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

L/T Finish: Ag plated

Operating Temperature: -40~+80°C Storage Temperature: -40~+100°C

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

Preconditioning: MSL3 according to JEDEC

Packing: 8mm tape with 4000/reel, ø180mm (7")

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- Commercial Lighting
- **Indoor Lighting**
- Backlight for LCD



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	100	mA
Pulse Forward Current (Duty 1/10, width 0.1ms)	I _{PF}	240	mA
Reverse Current @5V	I _R	10	μΑ
Electrostatics Discharge (HBM)	ESD	1000	V
Junction Temperature	Tj	110	°C
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	260	°C
Colour Rendering Index	CRI	80 (typ.)	

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	3.2	3.6	V	I _F =60mA	
Luminous Flux	Фу	20	22	26	lm	I _F =60mA	
Chromaticity	Х		0.3828			I COm A	
Coordinates	Υ		0.3803		I ^E =0(I _F =60mA	
Colour Temperature	ССТ	3710	4000	4260	К	I _F =60mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =60mA	

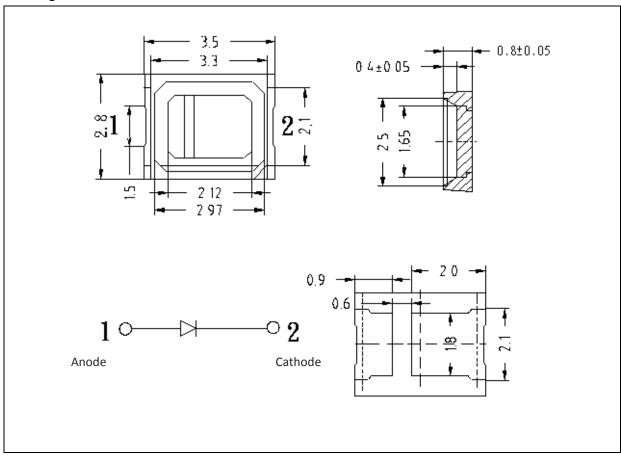
^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, Viewing angle($2\theta_{1/2}$) ±5%, CRI±5

^{2.} IS standard testing



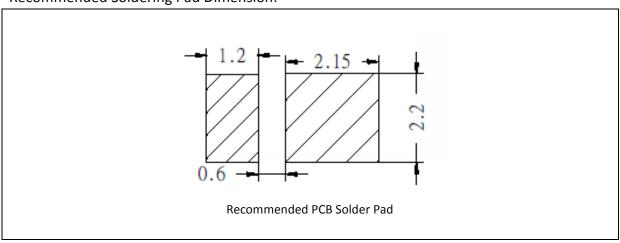
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 60 \text{mA}$):

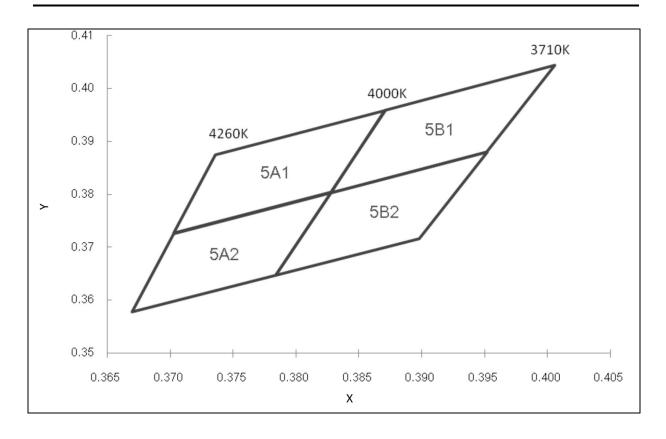
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	V
G	3.3	3.4	
Н	3.4	3.5	
I	3.5	3.6	

Luminous Flux Classifications ($I_F = 60$ mA):

Code	Min.	Max.	Unit
16	20	22	
17	22	24	lm
18	24	26	



CIE CHROMATICITY DIAGRAM:

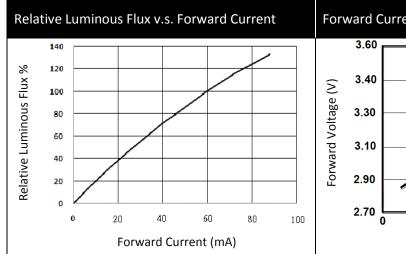


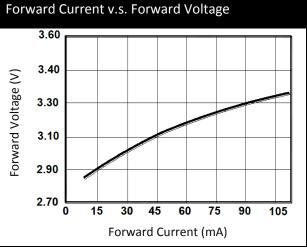
Chromaticity Coordinates Classifications ($I_F = 60 \text{mA}$):

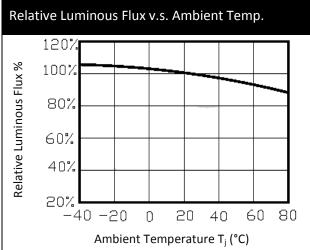
	1	l	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
5A1	0.3871	0.3959	0.3736	0.3874	0.3703	0.3726	0.3828	0.3803
5A2	0.3828	0.3803	0.3703	0.3726	0.3670	0.3578	0.3784	0.3647
5B1	0.4006	0.4044	0.3871	0.3959	0.3828	0.3803	0.3952	0.3880
5B2	0.3952	0.3880	0.3828	0.3803	0.3784	0.3647	0.3898	0.3716

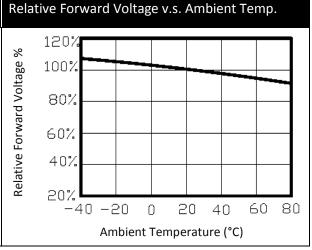


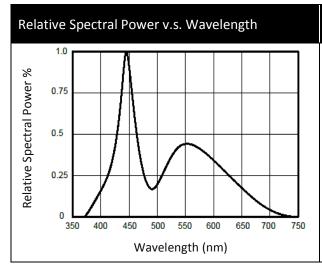
ELECTRO-OPTICAL CHARACTERISTICS:

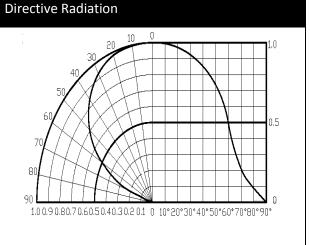




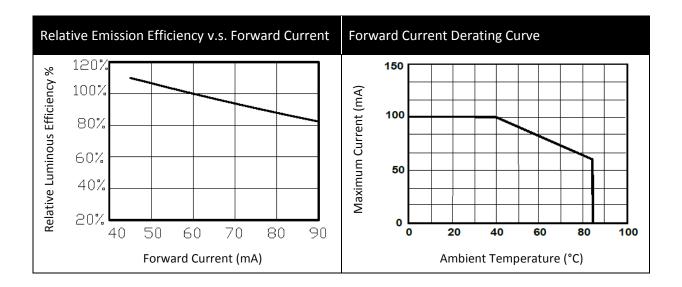








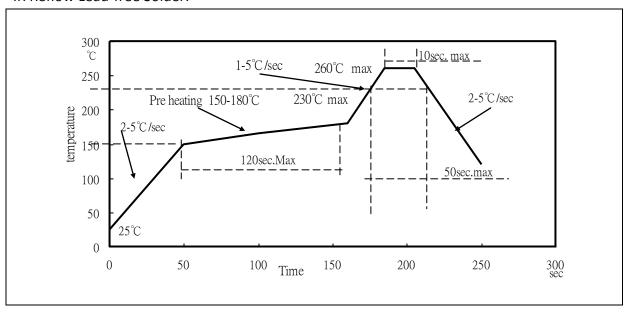






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



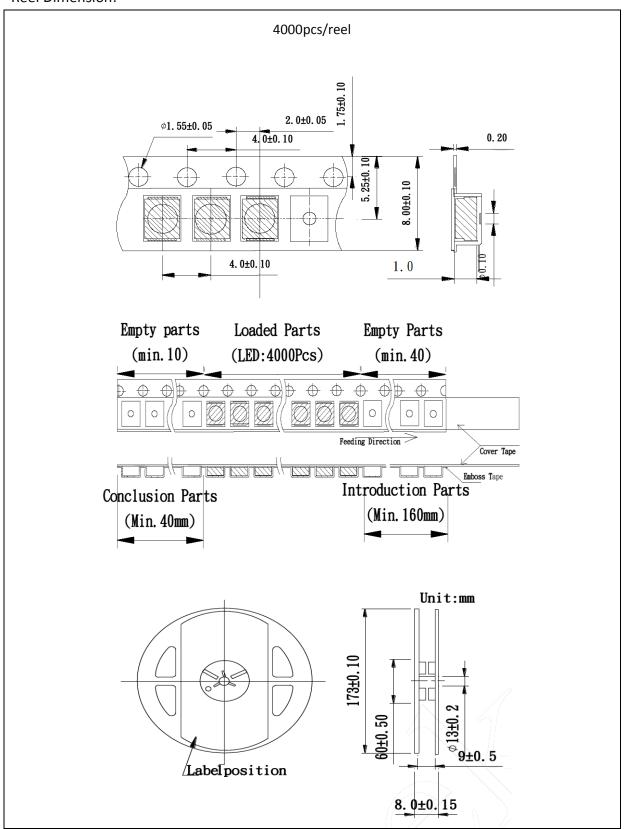
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended reflow temperature: 240°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

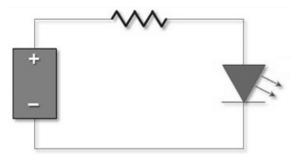
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	01/04/2015	Datasheet set-up.